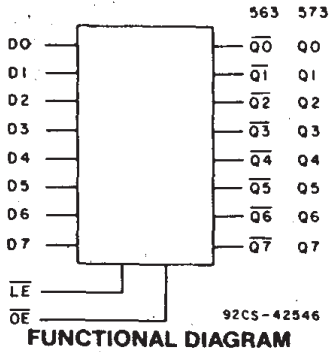


# CD54/74AC563, CD54/74AC573 CD54/74ACT563, CD54/74ACT573



Data sheet acquired from Harris Semiconductor  
SCHS291



## Octal Transparent Latch, 3-State

CD54/74AC/ACT563 - Inverting  
CD54/74AC/ACT573 - Non-Inverting

### Type Features:

- Buffered inputs
- Typical propagation delay:  
4.3 ns @  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $C_L = 50\text{ pF}$

The RCA-CD54/74AC563 and CD54/74AC573 and the CD54/74ACT563 and CD54/74ACT573 octal transparent 3-state latches use the RCA ADVANCED CMOS technology. The outputs are transparent to the inputs when the Latch Enable ( $\overline{LE}$ ) is HIGH. When the Latch Enable ( $\overline{LE}$ ) goes LOW, the data is latched. The Output Enable ( $\overline{OE}$ ) controls the 3-state outputs. When the Output Enable ( $\overline{OE}$ ) is HIGH, the outputs are in the high-impedance state. The latch operation is independent of the state of the Output Enable.

The CD74AC/ACT563 and CD74AC/ACT573 are supplied in 20-lead dual-in-line plastic packages (E suffix) and in 20-lead dual-in-line small-outline plastic packages (M suffix). Both package types are operable over the following temperature ranges: Commercial (0 to 70°C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to +125°C).

The CD54AC/ACT563 and CD54AC/ACT573, available in chip form (H suffix), are operable over the -55 to +125°C temperature range.

### Family Features:

- Exceeds 2-kV ESD Protection - MIL-STD-883, Method 3015
- SCR-Latchup-resistant CMOS process and circuit design
- Speed of bipolar FAST\*/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
- $\pm 24\text{-mA}$  output drive current
  - Fanout to 15 FAST\* ICs
  - Drives 50-ohm transmission lines

\*FAST is a Registered Trademark of Fairchild Semiconductor Corp.

TRUTH TABLE

| Output Enable | Latch Enable | Data | AC/ACT563 Output | AC/ACT573 Output |
|---------------|--------------|------|------------------|------------------|
| L             | H            | H    | L                | H                |
| L             | H            | L    | H                | L                |
| L             | L            | 1    | H                | L                |
| L             | L            | h    | L                | H                |
| H             | X            | X    | Z                | Z                |

Note:

- L = Low voltage level
- H = High voltage level
- 1 = Low voltage level one set-up time prior to the high to low latch enable transition
- h = High voltage level one set-up time prior to the high to low latch enable transition.
- X = Don't Care
- Z = High Impedance State

This data sheet is applicable to the CD74AC563, CD54/74AC573, and CD54/74ACT573. The CD54AC563 and CD54/74ACT563 were not acquired from Harris Semiconductor.

# CD54/74AC563, CD54/74AC573 CD54/74ACT563, CD54/74ACT573

**MAXIMUM RATINGS, Absolute-Maximum Values:**

|  |       |   |
|--|-------|---|
| DC SUPPLY-VOLTAGE ( $V_{CC}$ )   | ..... | -0.5 to 6 V   |
| DC INPUT DIODE CURRENT, $I_{IK}$ (for $V_i < -0.5$ V or $V_i > V_{CC} + 0.5$ V)                          | ..... | $\pm 20$ mA   |
| DC OUTPUT DIODE CURRENT, $I_{OK}$ (for $V_o < -0.5$ V or $V_o > V_{CC} + 0.5$ V)                         | ..... | $\pm 50$ mA   |
| DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, $I_o$ (for $V_o > -0.5$ V or $V_o < V_{CC} + 0.5$ V)    | ..... | $\pm 50$ mA   |
| DC $V_{CC}$ or GROUND CURRENT ( $I_{CC}$ or $I_{GND}$ )  | ..... | $\pm 100$ mA*                                       |
| POWER DISSIPATION PER PACKAGE ( $P_D$ ):   |       |   |
| For $T_A = -55$ to $+100^\circ\text{C}$ (PACKAGE TYPE E)   | ..... | 500 mW  |
| For $T_A = +100$ to $+125^\circ\text{C}$ (PACKAGE TYPE E)  | ..... | Derate Linearly at 8 mW/ $^\circ\text{C}$ to 300 mW |
| For $T_A = -55$ to $+70^\circ\text{C}$ (PACKAGE TYPE M)  | ..... | 400 mW  |
| For $T_A = +70$ to $+125^\circ\text{C}$ (PACKAGE TYPE M)   | ..... | Derate Linearly at 6 mW/ $^\circ\text{C}$ to 70 mW  |
| OPERATING-TEMPERATURE RANGE ( $T_A$ ):   |       |   |
| PACKAGE TYPE F   | ..... | -55 to $+125^\circ\text{C}$                         |
| PACKAGE TYPE E, M  | ..... | -40 to $+125^\circ\text{C}$                         |
| STORAGE TEMPERATURE ( $T_{stg}$ )  | ..... | -65 to $+150^\circ\text{C}$                         |
| LEAD TEMPERATURE (DURING SOLDERING):   |       |   |
| At distance $1/16 \pm 1/32$ in. ( $1.59 \pm 0.79$ mm) from case for 10 s maximum                         | ..... | $+265^\circ\text{C}$                                |
| Unit inserted into PC board min. thickness $1/16$ in. ( $1.59$ mm) with solder contacting lead tips only | ..... | $+300^\circ\text{C}$                                |

\*For up to 4 outputs per device; add  $\pm 25$  mA for each additional output.

**RECOMMENDED OPERATING CONDITIONS:**

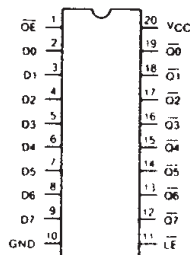
For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC  | LIMITS      |                | UNITS                |
|---|-------------|----------------|----------------------|
|   | MIN.        | MAX.           |                      |
| Supply-Voltage Range, $V_{CC}$ *:<br>(For $T_A =$ Full Package-Temperature Range)<br>AC Types<br>ACT Types                            | 1.5<br>4.5  | 5.5<br>5.5     | V<br>V               |
| DC Input or Output Voltage, $V_i, V_o$  | 0           | $V_{CC}$       | V                    |
| Operating Temperature, $T_A$ :  | -55         | $+125$         | $^\circ\text{C}$     |
| Input Rise and Fall Slew Rate, $dt/dv$<br>at 1.5 V to 3 V (AC Types)<br>at 3.6 V to 5.5 V (AC Types)<br>at 4.5 V to 5.5 V (ACT Types) | 0<br>0<br>0 | 50<br>20<br>10 | ns/V<br>ns/V<br>ns/V |

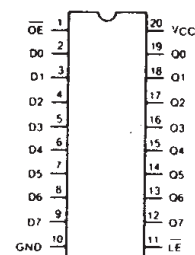
\*Unless otherwise specified, all voltages are referenced to ground.

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**TERMINAL ASSIGNMENT DIAGRAMS**



CD54/74AC563, CD54/74ACT563



CD54/74AC573, CD54/74ACT573

# CD54/74AC563, CD54/74AC573 CD54/74ACT563, CD54/74ACT573

STATIC ELECTRICAL CHARACTERISTICS: AC Series

| CHARACTERISTICS                                  | TEST CONDITIONS  |       | V <sub>CC</sub><br>(V) | AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C |      |            |      |             |      | UNITS |
|--|--|-------|------------------------|--|------|------------|------|-------------|------|-------|
|  |  |       |                        | +25  |      | -40 to +85 |      | -55 to +125 |      |       |
|  |  |       |                        | MIN.                                       | MAX. | MIN.       | MAX. | MIN.        | MAX. |       |
| High-Level Input Voltage<br>V <sub>IH</sub>      |  |       | 1.5                    | 1.2  | —    | 1.2        | —    | 1.2         | —    | V     |
|  |  |       | 3                      | 2.1  | —    | 2.1        | —    | 2.1         | —    |       |
|  |  |       | 5.5                    | 3.85                                       | —    | 3.85       | —    | 3.85        | —    |       |
| Low-Level Input Voltage<br>V <sub>IL</sub>       |  |       | 1.5                    | —  | 0.3  | —          | 0.3  | —           | 0.3  | V     |
|  |  |       | 3                      | —  | 0.9  | —          | 0.9  | —           | 0.9  |       |
|  |  |       | 5.5                    | —  | 1.65 | —          | 1.65 | —           | 1.65 |       |
| High-Level Output Voltage<br>V <sub>OH</sub>     | V <sub>IH</sub><br>or<br>V <sub>IL</sub>   | -0.05 | 1.5                    | 1.4  | —    | 1.4        | —    | 1.4         | —    | V     |
|  |  |       | 3                      | 2.9  | —    | 2.9        | —    | 2.9         | —    |       |
|  |  |       | 4.5                    | 4.4  | —    | 4.4        | —    | 4.4         | —    |       |
|  |  |       | 3                      | 2.58                                       | —    | 2.48       | —    | 2.4         | —    |       |
|  |  |       | 4.5                    | 3.94                                       | —    | 3.8        | —    | 3.7         | —    |       |
|  |  |       | 5.5                    | —  | —    | 3.85       | —    | —           | —    |       |
| Low-Level Output Voltage<br>V <sub>OL</sub>      | V <sub>IH</sub><br>or<br>V <sub>IL</sub>   | 0.05  | 1.5                    | —  | 0.1  | —          | 0.1  | —           | 0.1  | V     |
|  |  |       | 3                      | —  | 0.1  | —          | 0.1  | —           | 0.1  |       |
|  |  |       | 4.5                    | —  | 0.1  | —          | 0.1  | —           | 0.1  |       |
|  |  |       | 3                      | —  | 0.36 | —          | 0.44 | —           | 0.5  |       |
|  |  |       | 4.5                    | —  | 0.36 | —          | 0.44 | —           | 0.5  |       |
|  |  |       | 5.5                    | —  | —    | —          | 1.65 | —           | —    |       |
| Input Leakage Current<br>I <sub>I</sub>          | V <sub>CC</sub><br>or<br>GND   |       | 5.5                    | —  | ±0.1 | —          | ±1   | —           | ±1   | μA    |
|  |  |       |                        |  |      |            |      |             |      |       |
| 3-State Leakage Current<br>I <sub>OZ</sub>       | V <sub>IH</sub><br>or<br>V <sub>IL</sub><br>V <sub>O</sub> =<br>V <sub>CC</sub><br>or<br>GND |       | 5.5                    | —  | ±0.5 | —          | ±5   | —           | ±10  | μA    |
|  |  |       |                        |  |      |            |      |             |      |       |
| Quiescent Supply Current, MSI<br>I <sub>CC</sub> | V <sub>CC</sub><br>or<br>GND   | 0     | 5.5                    | —  | 8    | —          | 80   | —           | 160  | μA    |

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

# CD54/74AC563, CD54/74AC573 CD54/74ACT563, CD54/74ACT573

**STATIC ELECTRICAL CHARACTERISTICS: ACT Series**

| CHARACTERISTICS   | TEST CONDITIONS       |   | V <sub>CC</sub><br>(V) | AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C |      |            |      |             |      | UNITS |    |
|---|-----------------------|---|------------------------|--|------|------------|------|-------------|------|-------|----|
|   | V <sub>I</sub><br>(V) | I <sub>O</sub><br>(mA)  |                        | +25  |      | -40 to +85 |      | -55 to +125 |      |       |    |
|   |                       |   |                        | MIN.                                       | MAX. | MIN.       | MAX. | MIN.        | MAX. |       |    |
| High-Level Input Voltage  | V <sub>IH</sub>       |   | 4.5 to 5.5             | 2  | —    | 2          | —    | 2           | —    | V     |    |
| Low-Level Input Voltage   | V <sub>IL</sub>       |   | 4.5 to 5.5             | —  | 0.8  | —          | 0.8  | —           | 0.8  | V     |    |
| High-Level Output Voltage   | V <sub>OH</sub>       | V <sub>IH</sub> or V <sub>IL</sub><br>#, *                                    | -0.05                  | 4.5  | 4.4  | —          | 4.4  | —           | 4.4  | —     | V  |
|   |                       |   | -24                    | 4.5  | 3.94 | —          | 3.8  | —           | 3.7  | —     |    |
|   |                       |   | -75                    | 5.5  | —    | —          | 3.85 | —           | —    | —     |    |
|   |                       |   | -50                    | 5.5  | —    | —          | —    | —           | 3.85 | —     |    |
| Low-Level Output Voltage  | V <sub>OL</sub>       | V <sub>IH</sub> or V <sub>IL</sub><br>#, *                                    | 0.05                   | 4.5  | —    | 0.1        | —    | 0.1         | —    | 0.1   | V  |
|   |                       |   | 24                     | 4.5  | —    | 0.36       | —    | 0.44        | —    | 0.5   |    |
|   |                       |   | 75                     | 5.5  | —    | —          | —    | 1.65        | —    | —     |    |
|   |                       |   | 50                     | 5.5  | —    | —          | —    | —           | —    | 1.65  |    |
| Input Leakage Current   | I <sub>I</sub>        | V <sub>CC</sub> or GND  | 5.5                    | —  | ±0.1 | —          | ±1   | —           | ±1   | μA    |    |
| 3-State Leakage Current   | I <sub>OZ</sub>       | V <sub>IH</sub> or V <sub>IL</sub><br>V <sub>O</sub> = V <sub>CC</sub> or GND | 5.5                    | —  | ±0.5 | —          | ±5   | —           | ±10  | μA    |    |
| Quiescent Supply Current, MSI   | I <sub>CC</sub>       | V <sub>CC</sub> or GND  | 0                      | 5.5  | —    | 8          | —    | 80          | —    | 160   | μA |
| Additional Quiescent Supply Current per Input Pin<br>TTL Inputs High<br>1 Unit Load | ΔI <sub>CC</sub>      | V <sub>CC</sub> -2.1  | 4.5 to 5.5             | —  | 2.4  | —          | 2.8  | —           | 3    | mA    |    |

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#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

\*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

**ACT INPUT LOADING TABLE**

| INPUT           | UNIT LOAD* |        |
|-----------------|------------|--------|
|                 | ACT563     | ACT573 |
| $\overline{OE}$ | 0.87       | 0.87   |
| $\overline{Dn}$ | 0.5        | 0.5    |
| $\overline{LE}$ | 0.8        | 0.8    |

\*Unit load is ΔI<sub>CC</sub> limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

# CD54/74AC563, CD54/74AC573 CD54/74ACT563, CD54/74ACT573

PREREQUISITE FOR SWITCHING: AC Series

| CHARACTERISTICS       | SYMBOL          | V <sub>CC</sub><br>(V) | AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C |      |             |      | UNITS |
|-----------------------|-----------------|------------------------|--|------|-------------|------|-------|
|                       |                 |                        | -40 to +85                                 |      | -55 to +125 |      |       |
|                       |                 |                        | MIN.                                       | MAX. | MIN.        | MAX. |       |
| LE Pulse Width        | t <sub>w</sub>  | 1.5                    | 44   | —    | 50          | —    | ns    |
|                       |                 | 3.3*                   | 4.9  | —    | 5.6         | —    |       |
|                       |                 | 5†                     | 3.5  | —    | 4           | —    |       |
| Setup Time Data to LE | t <sub>su</sub> | 1.5                    | 2  | —    | 2           | —    | ns    |
|                       |                 | 3.3                    | 2  | —    | 2           | —    |       |
|                       |                 | 5                      | 2  | —    | 2           | —    |       |
| Hold Time Data to LE  | t <sub>h</sub>  | 1.5                    | 33   | —    | 38          | —    | ns    |
|                       |                 | 3.3                    | 3.7  | —    | 4.2         | —    |       |
|                       |                 | 5                      | 2.6  | —    | 3           | —    |       |

\*3.3 V: min. is @ 3 V

†5 V: min. is @ 4.5 V

SWITCHING CHARACTERISTICS: AC Series; t<sub>r</sub>, t<sub>f</sub> = 3 ns, C<sub>L</sub> = 50 pF

| CHARACTERISTICS   | SYMBOL                               | V <sub>CC</sub><br>(V) | AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C |      |             |      | UNITS |
|---|--------------------------------------|------------------------|--|------|-------------|------|-------|
|   |                                      |                        | -40 to +85                                 |      | -55 to +125 |      |       |
|   |                                      |                        | MIN.                                       | MAX. | MIN.        | MAX. |       |
| Propagation Delays:<br>Data to Qn<br>AC563  | t <sub>PLH</sub><br>t <sub>PHL</sub> | 1.5                    | —  | 119  | —           | 131  | ns    |
|   |                                      | 3.3*                   | 3.8  | 13.4 | 3.7         | 14.7 |       |
|   |                                      | 5†                     | 2.7  | 9.5  | 2.6         | 10.5 |       |
| AC573   | t <sub>PLH</sub><br>t <sub>PHL</sub> | 1.5                    | —  | 96   | —           | 106  | ns    |
|   |                                      | 3.3                    | 3.1  | 10.8 | 3           | 11.9 |       |
|   |                                      | 5                      | 2.2  | 7.7  | 2.1         | 8.5  |       |
| LE on Qn<br>AC563   | t <sub>PLH</sub><br>t <sub>PHL</sub> | 1.5                    | —  | 136  | —           | 150  | ns    |
|   |                                      | 3.3                    | 4.3  | 15.3 | 4.2         | 16.8 |       |
|   |                                      | 5                      | 3.1  | 10.9 | 3           | 12   |       |
| AC573   | t <sub>PLH</sub><br>t <sub>PHL</sub> | 1.5                    | —  | 136  | —           | 150  | ns    |
|   |                                      | 3.3                    | 4.3  | 15.3 | 4.2         | 16.8 |       |
|   |                                      | 5                      | 3.1  | 10.9 | 3           | 12   |       |
| Output Enable Times   | t <sub>pZL</sub><br>t <sub>pZH</sub> | 1.5                    | —  | 119  | —           | 131  | ns    |
|   |                                      | 3.3                    | 4.1  | 14.4 | 4           | 15.8 |       |
|   |                                      | 5                      | 2.7  | 9.5  | 2.6         | 10.5 |       |
| Output Disable Times  | t <sub>PLZ</sub><br>t <sub>PHZ</sub> | 1.5                    | —  | 131  | —           | 144  | ns    |
|   |                                      | 3.3                    | 3.7  | 13.1 | 3.6         | 14.4 |       |
|   |                                      | 5                      | 3  | 10.5 | 2.9         | 11.5 |       |
| Power Dissipation Capacitance   | C <sub>PD</sub> §                    | —                      | 63 Typ.                                    |      | 63 Typ.     |      | pF    |
| Min. (Valley) V <sub>OH</sub><br>During Switching of Other Outputs<br>(Output Under Test Not Switching) | V <sub>OHV</sub><br>See Fig. 1       | 5                      | 4 Typ. @ 25°C                              |      |             |      | V     |
| Max. (Peak) V <sub>OL</sub><br>During Switching of Other Outputs<br>(Output Under Test Not Switching)   | V <sub>OLP</sub><br>See Fig. 1       | 5                      | 1 Typ. @ 25°C                              |      |             |      | V     |
| Input Capacitance   | C <sub>i</sub>                       | —                      | —  | 10   | —           | 10   | pF    |
| 3-State Output Capacitance  | C <sub>o</sub>                       | —                      | —  | 15   | —           | 15   | pF    |

\*3.3 V: min. is @ 3.6 V  
max. is @ 3 V

†5 V: min. is @ 5.5 V  
max. is @ 4.5 V

§C<sub>PD</sub> is used to determine the dynamic power consumption, per latch.

P<sub>D</sub> = V<sub>CC</sub><sup>2</sup> f<sub>i</sub> (C<sub>PD</sub> + C<sub>L</sub>) where f<sub>i</sub> = input frequency

C<sub>L</sub> = output load capacitance

V<sub>CC</sub> = supply voltage.

Technical Data

# CD54/74AC563, CD54/74AC573 CD54/74ACT563, CD54/74ACT573

**PREREQUISITE FOR SWITCHING: ACT Series**

| CHARACTERISTICS       | SYMBOL          | V <sub>CC</sub><br>(V) | AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C |      |             |      | UNITS |
|-----------------------|-----------------|------------------------|--|------|-------------|------|-------|
|                       |                 |                        | -40 to +85                                 |      | -55 to +125 |      |       |
|                       |                 |                        | MIN.                                       | MAX. | MIN.        | MAX. |       |
| LE Pulse Width        | t <sub>w</sub>  | 5†                     | 3.5  | —    | 4           | —    | ns    |
| Setup Time Data to LE | t <sub>su</sub> | 5                      | 2  | —    | 2           | —    | ns    |
| Hold Time Data to LE  | t <sub>h</sub>  | 5                      | 2.6  | —    | 3           | —    | ns    |

†5 V: min. is @ 4.5 V

**SWITCHING CHARACTERISTICS: ACT Series; t<sub>r</sub>, t<sub>f</sub> = 3 ns, C<sub>L</sub> = 50 pF**

| CHARACTERISTICS   | SYMBOL                               | V <sub>CC</sub><br>(V) | AMBIENT TEMPERATURE (T <sub>A</sub> ) - °C |      |             |      | UNITS |
|---|--------------------------------------|------------------------|--|------|-------------|------|-------|
|   |                                      |                        | -40 to +85                                 |      | -55 to +125 |      |       |
|   |                                      |                        | MIN.                                       | MAX. | MIN.        | MAX. |       |
| Propagation Delays:<br>Data to Qn<br>563  | t <sub>PLH</sub>                     | 5†                     | 2.9  | 10.4 | 2.9         | 11.4 | ns    |
|   | t <sub>PHL</sub>                     |                        |  |      |             |      |       |
| 573   |                                      |                        | 2.7  | 9.4  | 2.6         | 10.4 |       |
| LE to Qn<br>563<br>573  | t <sub>PLH</sub><br>t <sub>PHL</sub> | 5                      | 3.2  | 11.4 | 3.1         | 12.5 |       |
| Output Enable Times   | t <sub>PZL</sub><br>t <sub>PZH</sub> | 5                      | 3.5  | 12.3 | 3.4         | 13.5 | ns    |
| Output Disable Times  | t <sub>PLZ</sub><br>t <sub>PHZ</sub> | 5                      | 3.2  | 11.4 | 3.1         | 12.5 | ns    |
| Power Dissipation Capacitance   | C <sub>PD</sub> §                    | —                      | 63 Typ.                                    |      | 63 Typ.     |      | pF    |
| Min. (Valley) V <sub>OH</sub><br>During Switching of Other Outputs<br>(Output Under Test Not Switching) | V <sub>OHV</sub><br>See Fig. 1       | 5                      | 4 Typ. @ 25°C                              |      |             |      | V     |
| Max. (Peak) V <sub>OL</sub><br>During Switching of Other Outputs<br>(Output Under Test Not Switching)   | V <sub>OLP</sub><br>See Fig. 1       | 5                      | 1 Typ. @ 25°C                              |      |             |      | V     |
| Input Capacitance   | C <sub>I</sub>                       | —                      | —  | 10   | —           | 10   | pF    |
| 3-State Output Capacitance  | C <sub>O</sub>                       | —                      | —  | 15   | —           | 15   | pF    |

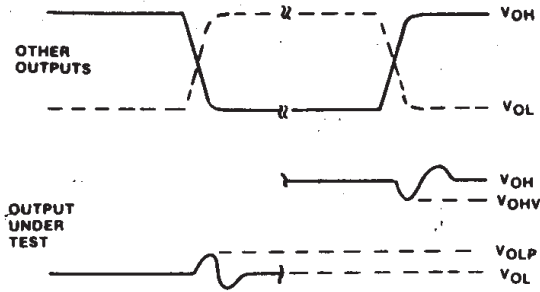
†5 V: min. is @ 5.5 V  
max. is @ 4.5 V

§C<sub>PD</sub> is used to determine the dynamic power consumption, per latch.  
 $P_D = V_{CC}^2 f_i (C_{PD} + C_L) + V_{CC} \Delta I_{CC}$  where f<sub>i</sub> = input frequency  
 C<sub>L</sub> = output load capacitance  
 V<sub>CC</sub> = supply voltage.

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# CD54/74AC563, CD54/74AC573 CD54/74ACT563, CD54/74ACT573

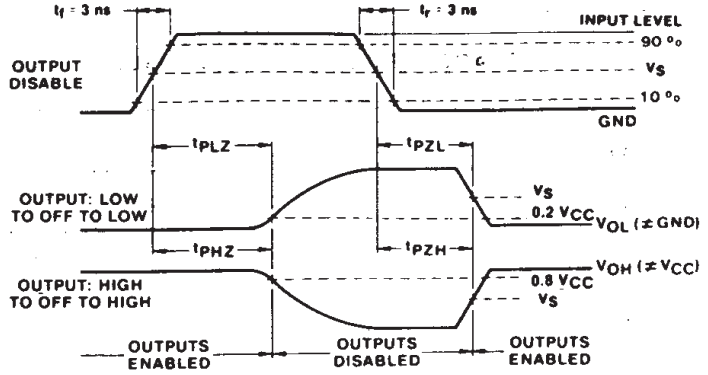
## PARAMETER MEASUREMENT INFORMATION



- NOTES:
1.  $V_{OHV}$  and  $V_{OLP}$  ARE MEASURED WITH RESPECT TO A GROUND REFERENCE NEAR THE OUTPUT UNDER TEST.
  2. INPUT PULSES HAVE THE FOLLOWING CHARACTERISTICS:  
PRR: 1 MHz,  $t_r$ : 3 ns,  $t_f$ : 3 ns, SKEW: 1 ns.
  3. R.F. FIXTURE WITH 700-MHz DESIGN RULES REQUIRED. IC SHOULD BE SOLDERED INTO TEST BOARD AND BYPASSED WITH 0.1  $\mu$ F CAPACITOR. SCOPE AND PROBES REQUIRE 700-MHz BANDWIDTH.

92CS-4240E

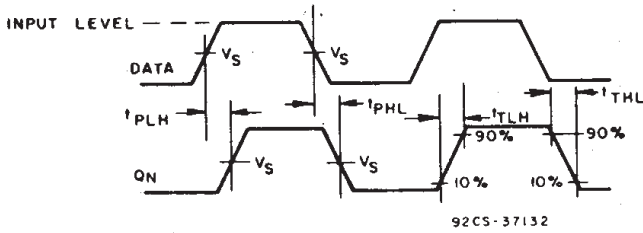
Fig. 1 - Simultaneous switching transient waveforms.



92CM-42405

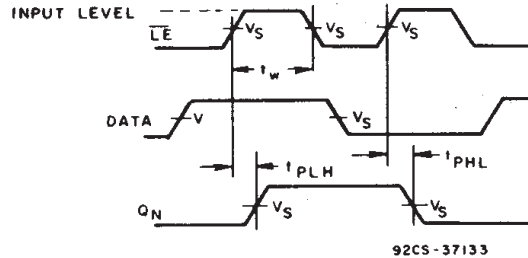
\*FOR AC SERIES ONLY: WHEN  $V_{CC} = 1.5$  V,  $R_L = 1$  k $\Omega$

Fig. 2 - Three-state propagation delay waveforms and test circuit.



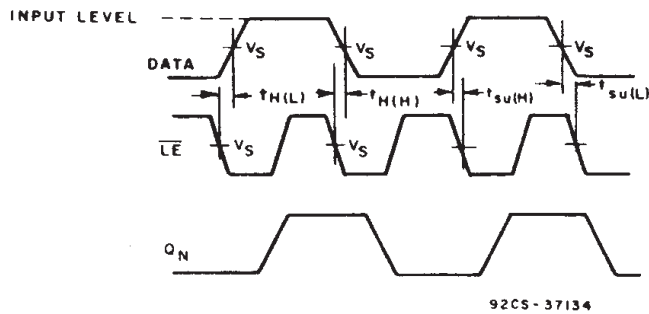
92CS-37132

Fig. 3 - Data to Qn output propagation delays.



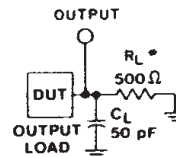
92CS-37133

Fig. 4 - Latch enable propagation delays.



92CS-37134

Fig. 5 - Latch enable prerequisite times.



\*FOR AC SERIES ONLY: WHEN  $V_{CC} = 1.5$  V,  $R_L = 1$  k $\Omega$

92CS-42389

Fig. 6 - Test circuit.

|                                 | CD54/74AC    | CD54/74ACT   |
|---------------------------------|--------------|--------------|
| Input Level                     | $V_{CC}$     | 3 V          |
| Input Switching Voltage, $V_S$  | $0.5 V_{CC}$ | 1.5 V        |
| Output Switching Voltage, $V_S$ | $0.5 V_{CC}$ | $0.5 V_{CC}$ |

**PACKAGING INFORMATION**

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">CD54AC573F3A</a>  | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD54AC573F3A        |
| <a href="#">CD54ACT573F3A</a> | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD54ACT573F3A       |
| <a href="#">CD74AC573E</a>    | Active        | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74AC573E          |
| <a href="#">CD74AC573M</a>    | Obsolete      | Production           | SOIC (DW)   20 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | AC573M              |
| <a href="#">CD74AC573M96</a>  | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | AC573M              |
| <a href="#">CD74ACT573E</a>   | Active        | Production           | PDIP (N)   20  | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74ACT573E         |
| <a href="#">CD74ACT573M</a>   | Obsolete      | Production           | SOIC (DW)   20 | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | ACT573M             |
| <a href="#">CD74ACT573M96</a> | Active        | Production           | SOIC (DW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | ACT573M             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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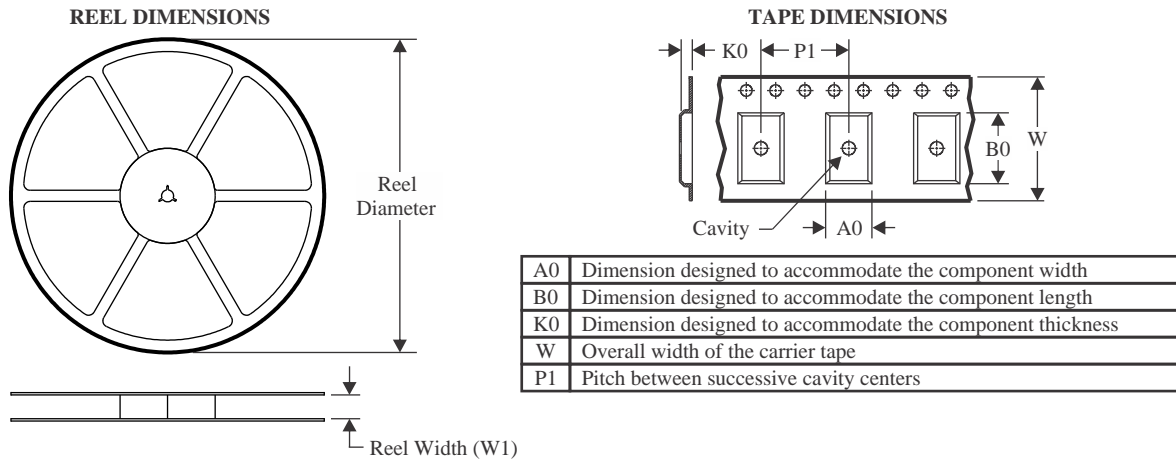
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF CD54AC573, CD54ACT573, CD74AC573, CD74ACT573 :**

- Catalog : [CD74AC573](#), [CD74ACT573](#)
- Military : [CD54AC573](#), [CD54ACT573](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

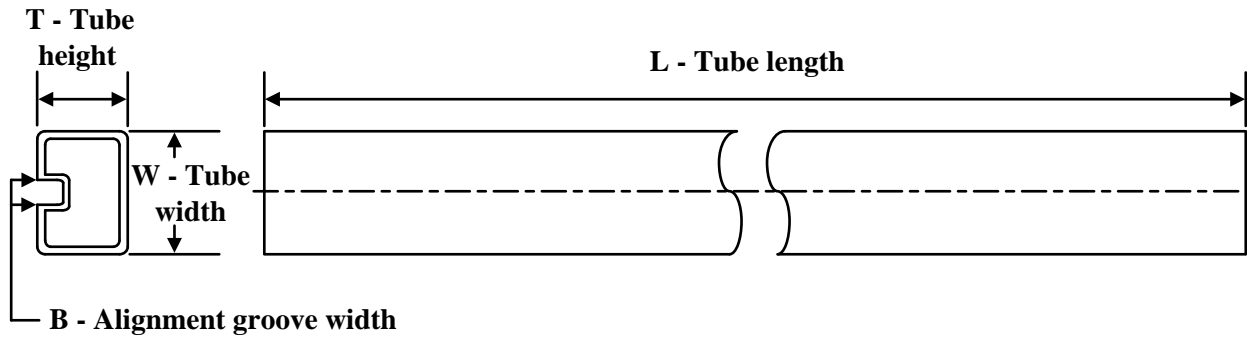
| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD74AC573M96  | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| CD74ACT573M96 | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74AC573M96  | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| CD74ACT573M96 | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |

**TUBE**


\*All dimensions are nominal

| Device      | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD74AC573E  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| CD74ACT573E | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |

J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14                     | 16                     | 18                     | 20                     |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A             | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX         | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN         | —                      | —                      | —                      | —                      |
| C MAX         | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN         | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package is hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

# DW0020A



# PACKAGE OUTLINE

## SOIC - 2.65 mm max height

SOIC



4220724/A 05/2016

**NOTES:**

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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